- **Designed for Digital Data Transmission Over 50-Ω to 500-Ω Coaxial Cable, Strip Line, or Twisted Pair**
- **High Speed**
  t_{pd} = 20 ns Maximum at C_L = 15 pF
- **TTL Compatible With Single 5-V Supply**
- **2.4-V Output at I_{OH} = –75 mA**
- **Uncommitted Emitter-Follower Output Structure for Party-Line Operation**
- **Short-Circuit Protection**
- **AND-OR Logic Configuration**
- **Designed for Use With Triple Line Receivers SN55122, SN75122**
- **Designed to Be Interchangeable With Signetics N8T13**

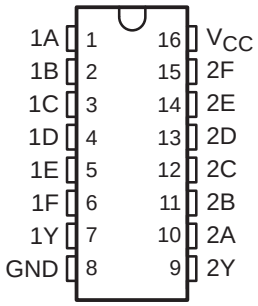
description

The SN55121 and SN75121 dual line drivers are designed for digital data transmission over lines having impedances from 50 to 500 Ω. They are also compatible with standard TTL logic and supply-voltage levels.

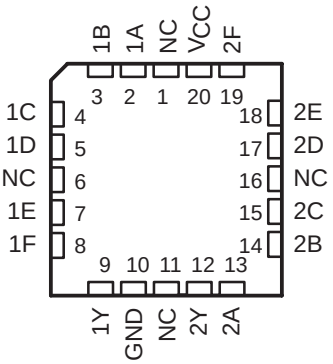
The low-impedance emitter-follower outputs of the SN55121 and SN75121 can drive terminated lines such as coaxial cable or twisted pair. Having the outputs uncommitted allows wired-OR logic to be performed in party-line applications. Output short-circuit protection is provided by an internal clamping network that turns on when the output voltage drops below approximately 1.5 V. All of the inputs are in conventional TTL configuration and the gating can be used during power-up and power-down sequences to ensure that no noise is introduced to the line.

The SN55121 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN75121 is characterized for operation from 0°C to 70°C.

SN55121 . . . J PACKAGE
SN75121 . . . D OR N PACKAGE
(TOP VIEW)



SN55121 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

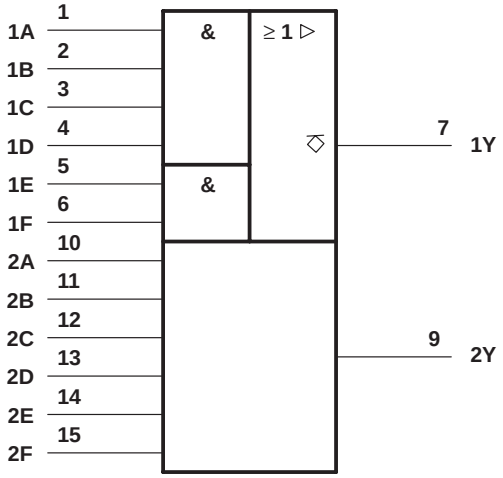
THE SN75121 IS NOT RECOMMENDED FOR NEW DESIGNS

FUNCTION TABLE

INPUTS						OUTPUT
A	B	C	D	E	F	Y
H	H	H	H	X	X	H
X	X	X	X	H	H	H
All other input combinations						L

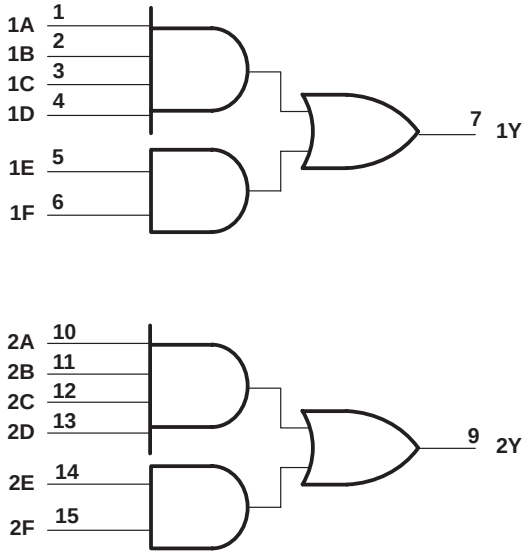
H = high level, L = low level, X = irrelevant

logic symbol†

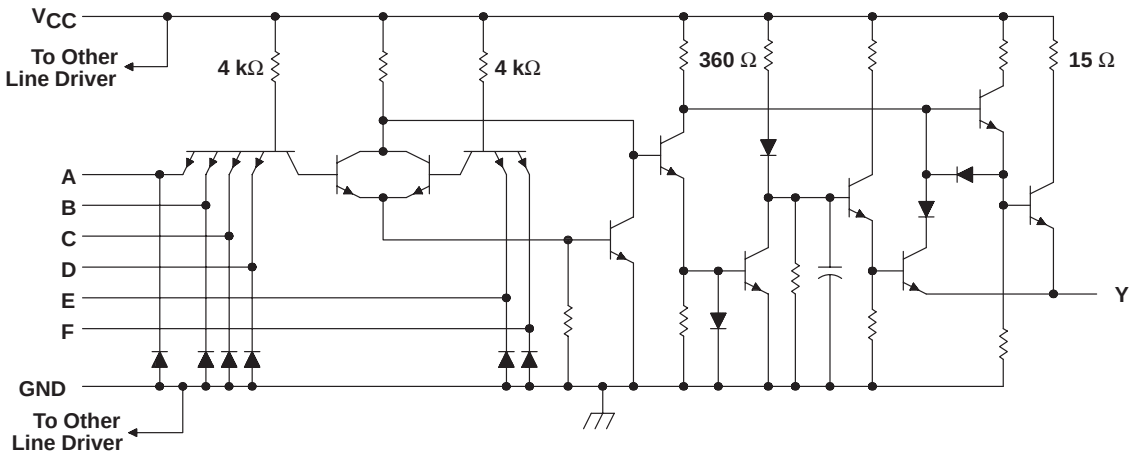


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)



schematic (each driver)



All resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1) . . . . . 6 V
Input voltage . . . . . 6 V
Output voltage . . . . . 6 V
Continuous total power dissipation . . . . . See Dissipation Rating Table
Storage temperature range, T_{stg} . . . . . –65°C to 150°C
Case temperature for 60 seconds: FK package . . . . . 260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J package . . . . . 300°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or N package . . . . . 260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to both ground terminals connected together.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING	$T_A = 125°C$ POWER RATING
D	950 mW	7.6 mW/°C	608 mW	—
FK‡	1375 mW	11.0 mW/°C	880 mW	275 mW
J‡	1375 mW	11.0 mW/°C	880 mW	275 mW
N	1150 mW	9.2 mW/°C	736 mW	—

‡ In the FK and J packages, SN55121 chips are either silver glass or alloy mounted.

recommended operating conditions

	SN55121			SN75121			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.75	5	5.25	4.75	5	5.25	V
High-level input voltage, V_{IH}	2			2			V
Low-level input voltage, V_{IL}			0.8			0.8	V
High-level output current, I_{OH}			–75			–75	mA
Operating free-air temperature, T_A	–55		125	0		70	°C

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	MAX	UNIT
V_{IK}	Input clamp voltage	V_{CC} = 5 V,	I_I = –12 mA			–1.5	V
$V_{(BR)}$	Breakdown voltage	V_{CC} = 5 V,	I_I = 10 mA		5.5		V
V_{OH}	High-level output voltage	V_{IH} = 2 V,	I_{OH} = –75 mA,	See Note 2	2.4		V
I_{OH}	High-level output current	V_{CC} = 5 V, T_A = 25°C,	V_{IH} = 4.5 V, See Note 2	V_{OH} = 2 V,	–100	–250	mA
I_{OL}	Low-level output current	V_{IL} = 0.8 V,	V_{OL} = 0.4 V,	See Note 2		–800	μA
$I_{O(off)}$	Off-state output current	V_{CC} = 3 V,	V_O = 3 V			500	μA
I_{IH}	High-level output current	V_I = 4.5 V				40	μA
I_{IL}	Low-level output current	V_I = 0.4 V			–0.1	–1.6	mA
I_{OS}	Short-circuit output current†	V_{CC} = 5 V,	T_A = 25°C			–30	mA
I_{CCH}	Supply current, outputs high	V_{CC} = 5.25 V,	All inputs at 2 V,	Outputs open		28	mA
I_{CCL}	Supply current, outputs low	V_{CC} = 5.25 V,	All inputs at 0.8 V,	Outputs open		60	mA

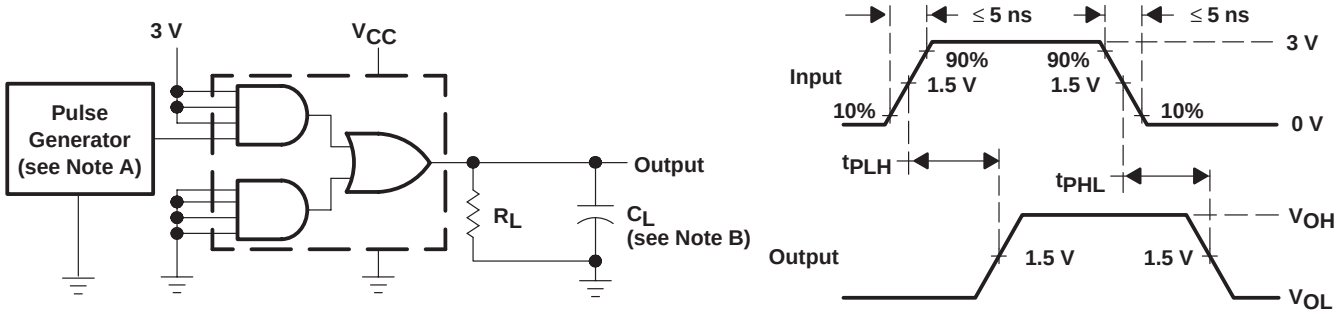
† Not more than one output should be shorted at a time.

NOTE 2: The output voltage and current limits are valid for any appropriate combination of high and low inputs specified by the function table for the desired output.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high level output	R_L = 37 Ω,	C_L = 15 pF,	See Figure 1		11	20	ns
t_{PHL}	Propagation delay time, high-to-low level output					8	20	
t_{PLH}	Propagation delay time, low-to-high level output	R_L = 37 Ω,	C_L = 1000 pF,	See Figure 1		22	50	ns
t_{PHL}	Propagation delay time, high-to-low level output					20	50	

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT VOLTAGE WAVEFORMS

NOTES: A. The pulse generator has the following characteristics: $Z_O \approx 50\ \Omega$, t_W = 200 ns, duty cycle ≤ 50%, PRR ≤ 500 kHz.
B. C_L includes probe and jig capacitance.

Figure 1. Test Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS

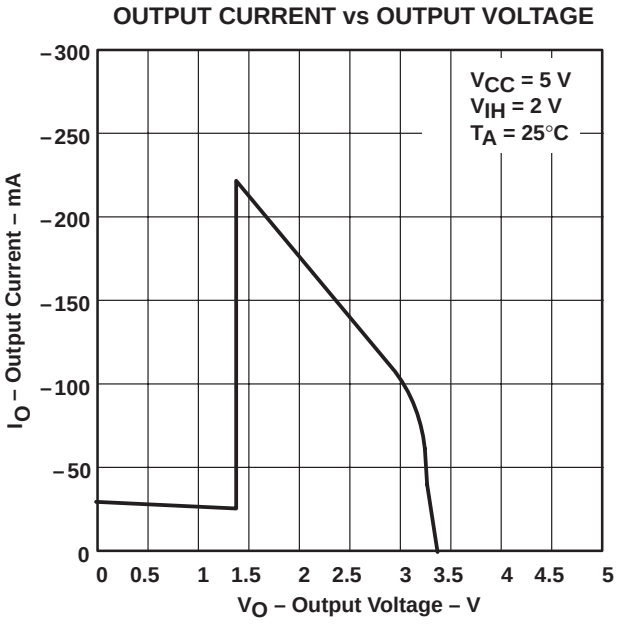


Figure 2

APPLICATION INFORMATION

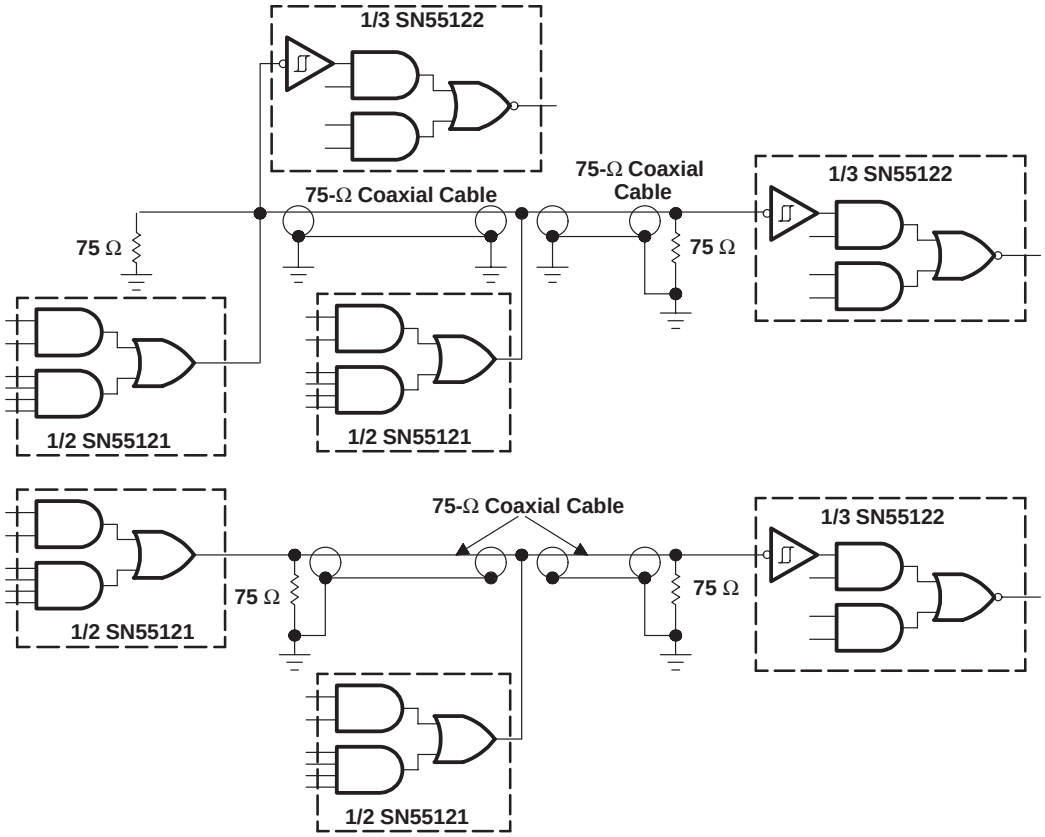


Figure 3. Single-Ended Party-Line Circuits

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN75121N	Active	Production	PDIP (N) | 16	25 | TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75121N
SN75121N.A	Active	Production	PDIP (N) | 16	25 | TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75121N
SN75121NSR	Active	Production	SOP (NS) | 16	2000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75121
SN75121NSR.A	Active	Production	SOP (NS) | 16	2000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75121

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

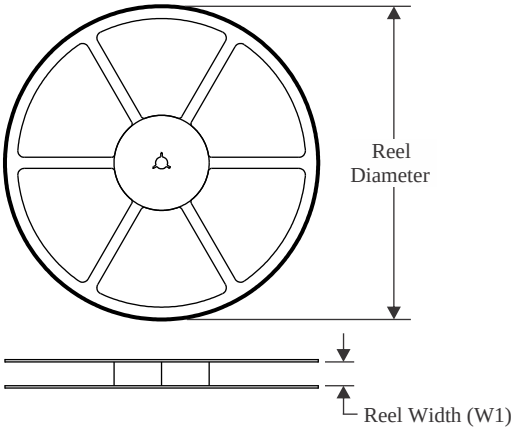
(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

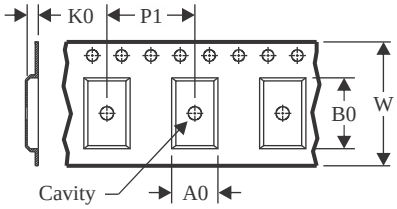
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

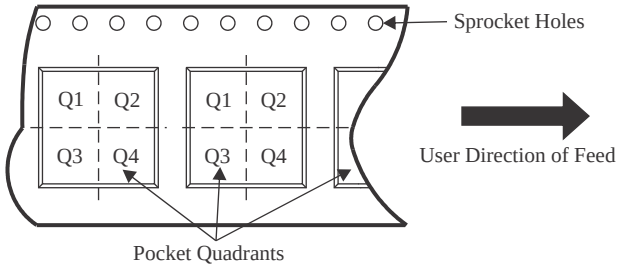


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

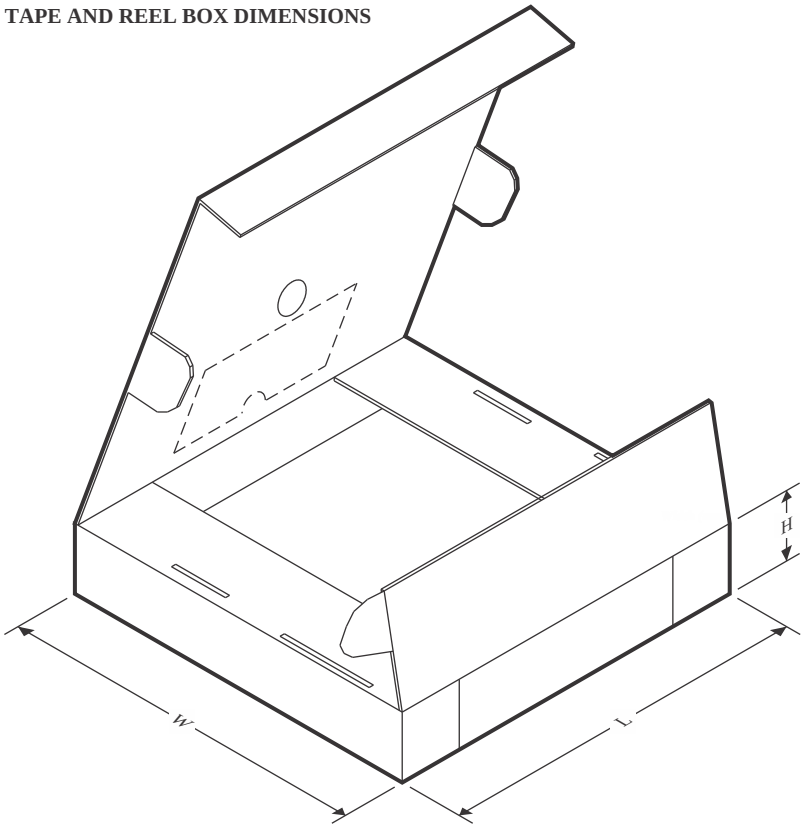
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75121NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

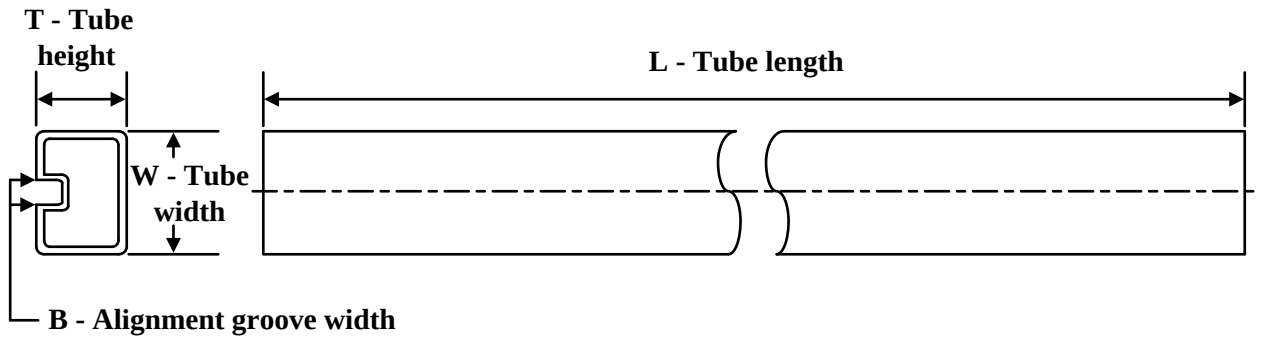
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75121NSR	SOP	NS	16	2000	353.0	353.0	32.0

TUBE



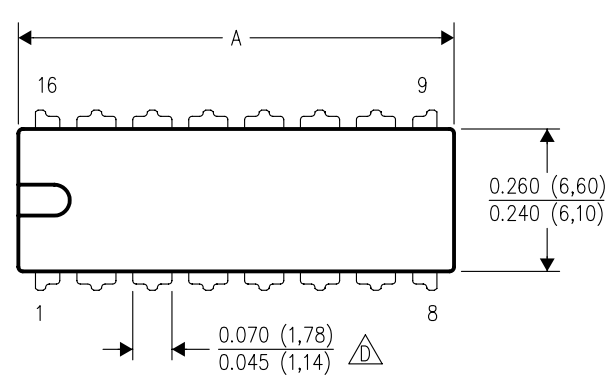
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN75121N	N	PDIP	16	25	506	13.97	11230	4.32
SN75121N.A	N	PDIP	16	25	506	13.97	11230	4.32

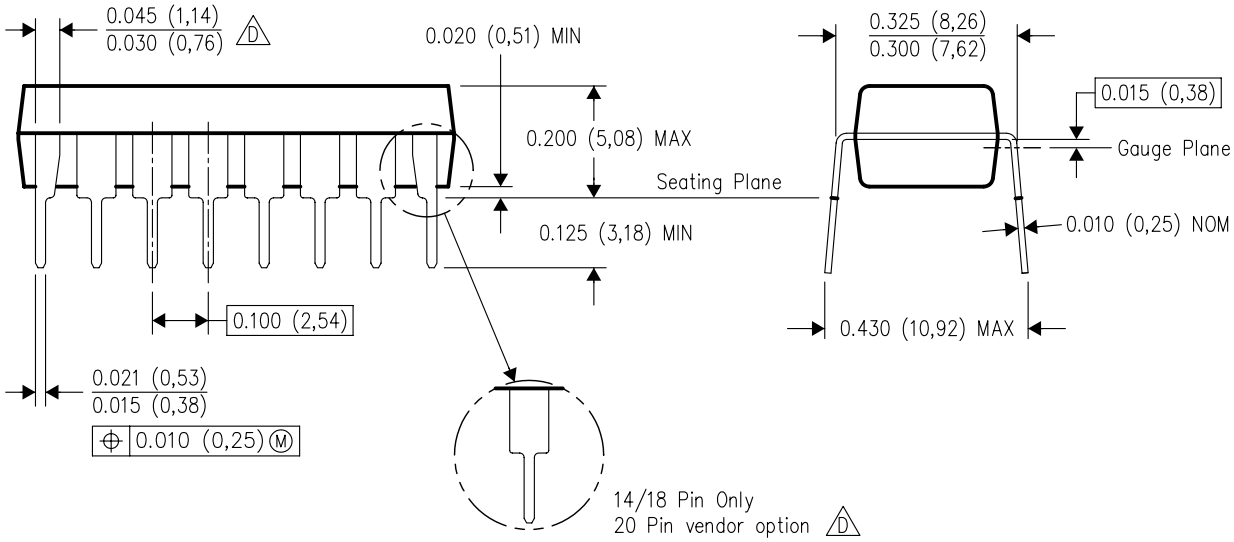
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN

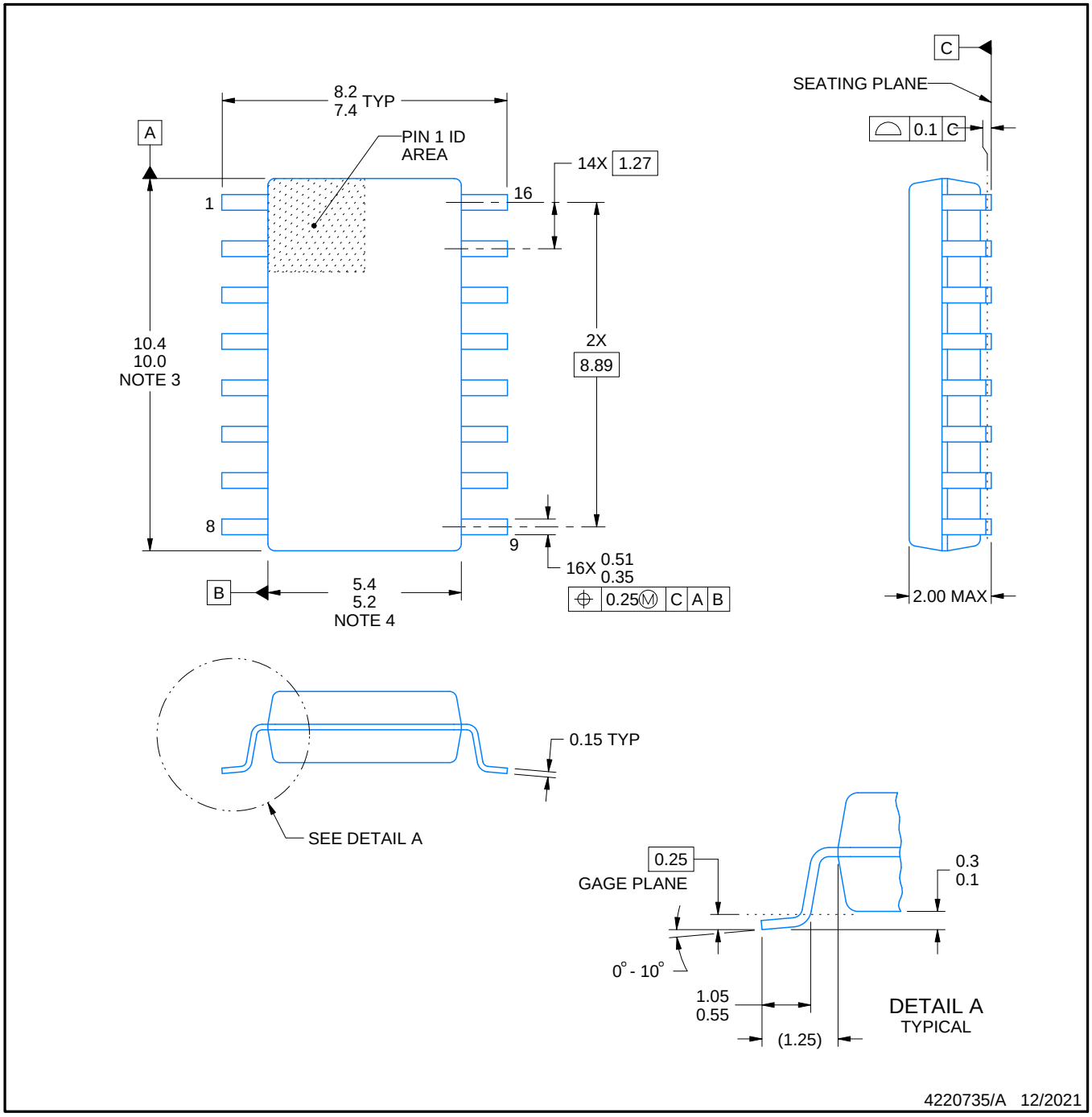


DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



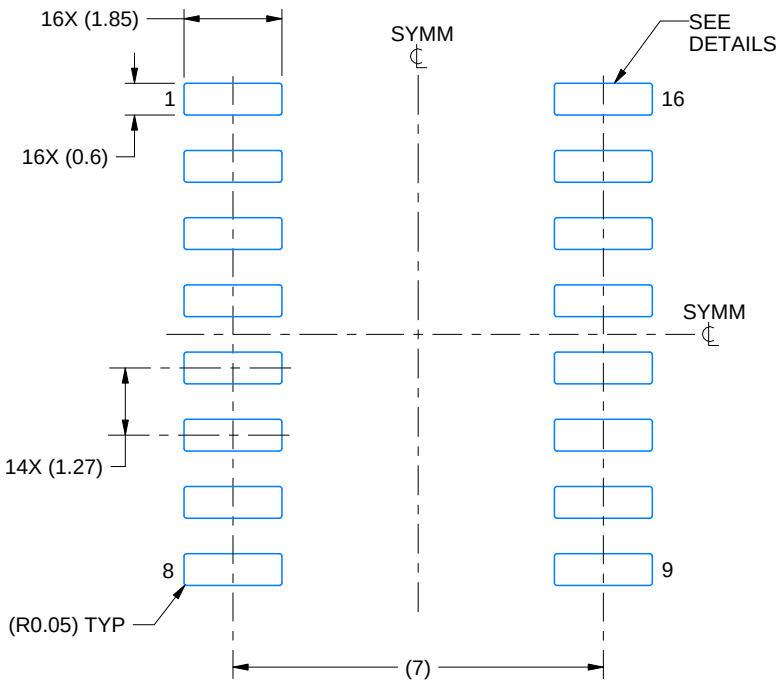
4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

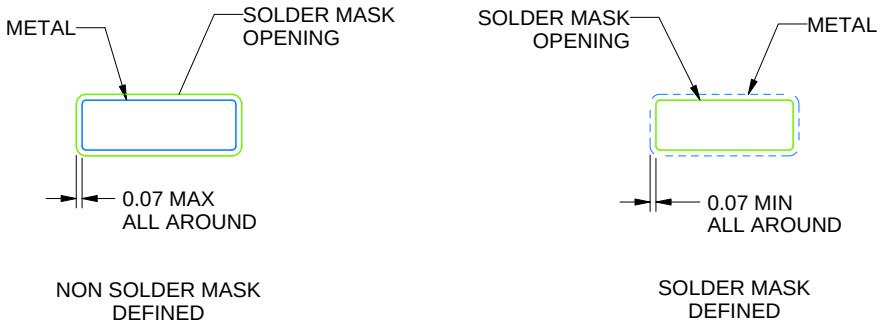


NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



LAND PATTERN EXAMPLE
SCALE:7X

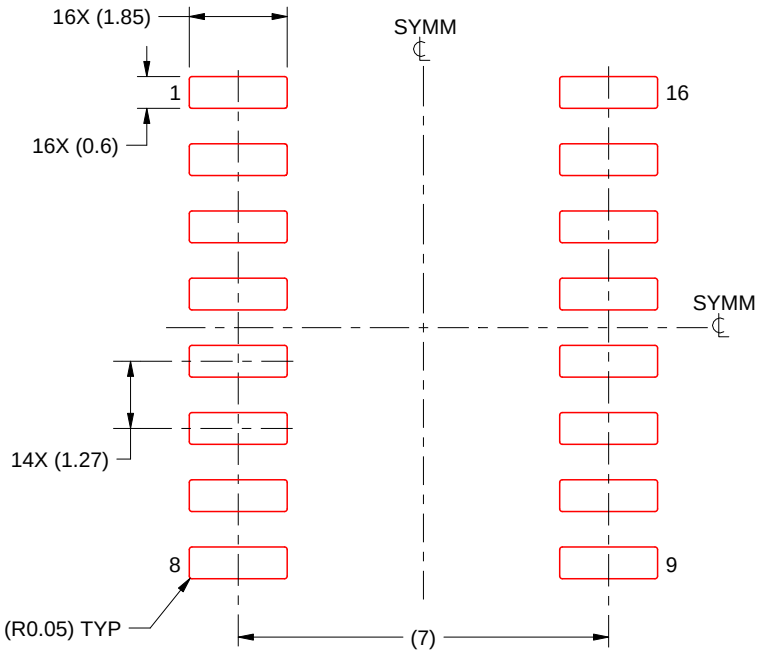


SOLDER MASK DETAILS

4220735/A 12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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